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Adsorption-Controlled Growth and Properties of Epitaxial SnO Films

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When it comes to providing the unusual combination of optical transparency, p-type conductivity, and relatively high mobility, Sn^{2+} -based oxides are promising candidates. Epitaxial films of the simplest Sn^{2+} oxide, SnO, are grown in an adsorption-controlled regime at 380° C on Al₂O₃ substrates by molecular-beam epitaxy, where the excess volatile SnO_x desorbs from the film surface. A commensurately strained monolayer and an accompanying van der Waals gap is observed near the substrate interface, promoting layers with high structural perfection notwithstanding a large epitaxial lattice mismatch (-12%). The unintentionally doped films exhibit p-type conductivity with carrier concentration $2.5 \times 10^{16}/\mathrm{cm}^3$ and mobility 2.4 cm²V⁻¹s⁻¹ at room temperature. Additional physical properties are measured and linked to the Sn²⁺ valence state and corresponding lone-pair charge density distribution.

I. INTRODUCTION

The amalgamation of high electrical conductivity and optical transparency within transparent conducting oxides (TCOs) is critically important for the development of next generation, high efficiency photovoltaics and interactive transparent electronics.¹ To date, designing TCOs has mainly involved doping wide-bandgap semiconductors. While this methodology has successfully produced *n*-type materials with low electron effective masses and high mobilities,^{2–4} the synthesis of *p*-type TCOs with equally desirably properties has been considerably more challenging.

Recent high-throughput searches founded on firstprinciple calculations identify Sn^{2+} -based oxides as promising candidates for optically transparent *p*-type conductors.⁵ In addition to exhibiting low hole effective masses and large band gaps, these compounds also display attractive dopant characteristics in which shallow acceptor states give rise to intrinsic *p*-type behavior that remain uncompensated by the energetically-costly formation of oxygen-vacancy donor states.^{5–7} Unfortunately, tin robustly prefers the Sn^{4+} oxidation state, making the stabilization of Sn^{2+} -based oxides difficult.^{8–10}

Of all compounds involving Sn^{2+} , stannous oxide (SnO), with its simple binary structure, represents a quintessential model system to investigate and demonstrate valence stabilization in high-quality singlecrystalline form. Furthermore, SnO is of fundamental importance for its pressure-induced insulatormetal phase transition¹¹ which concomitantly kindles superconductivity^{11,12} as observed in isostructural FeSe^{13,14} as well as of technological relevance for next-generation computing^{15–18} and energy-sustainable applications^{19,20}. Despite its simple structure and unique properties, the quality of SnO films reported in the literature varies greatly.^{15,21–27} Part of the challenge with obtaining high-quality SnO is stabilizing Sn²⁺ over Sn⁴⁺.^{28,29} Indeed, thermodynamic phase diagrams omit SnO considering it metastable and disproportionating to Sn and SnO₂.³⁰

Strategies to stabilize Sn^{2+} include using metal-organic precursors²⁸ and exploiting the higher vapor pressure of SnO suboxides over SnO_2 .^{4,21–25,31} Here, we adopt the latter approach and present a study of the growth and properties of SnO films produced using molecular-beam epitaxy. The single crystalline layers are deposited in a spiral growth mode at temperatures compatible with back-end-of-the-line fabrication processes. After establishing that these epitaxial SnO films have the highest structural perfection as well as the lowest background carrier concentrations reported to date, we proceed to investigate the electronic properties of SnO by combining



FIG. 1. Phase-pure litharge SnO/Al₂O₃(1 $\bar{1}02$) films produced via molecular-beam epitaxy. (a) Backscattered Raman Stokes spectrum and (b) XRD θ -2 θ scan establishing phase-pure litharge SnO/Al₂O₃(1 $\bar{1}02$) films. The inserts depict (a) atomic displacement patterns corresponding to Raman-active vibrational modes and (b) the film/substrate orientational relationship.

spectroscopic measurements with first-principles calculation results.

II. RESULTS AND DISCUSSION

A. Phase identification

SnO films are grown on r-plane $Al_2O_3(1\overline{1}02)$ substrates using molecular-beam epitaxy in a Veeco GEN10 stainless-steel ultra-high-vacuum system (base pressure $= 1 \times 10^{-8}$ Torr) under a background O₂ partial pressure of 5×10^{-7} Torr. SnO is supplied from a SnO₂-containing (99.996% purity, Alfa Aesar) effusion cell operating near 950 °C. In situ reflection high-energy electron diffraction patterns demonstrate that layers deposited at a substrate temperature T_s below 370°C are amorphous and that no deposition occurs above 400 °C. At high homologous growth temperatures, incident adsorbed SnO_x species return to the gas phase due to their low sticking probabilities rather than accumulating on the growth surface.^{32,33} Films grown between $370 \leq T_s \leq 400^{\circ}$ C are crystalline and represent the main focus of this Letter. The following discussion is for a SnO layer deposited at $380 \,^{\circ}\text{C}$ on r-plane $Al_2O_3(1\overline{1}02)$ in a background O_2 partial pressure of 5×10^{-7} Torr.

The crystallographic phase of SnO/Al₂O₃(1102) layers is established using Raman spectroscopy and xray diffraction (XRD). Figure 1(a) is a representative backscattered Stokes spectrum.³⁴³⁵ The peaks at $\hbar\omega$ = 13.7 and 25.8 meV correspond to symmetry-allowed vibrational excitations unique to specific crystallographic phases. To identify the features and corresponding phases, we decompose zone-center phonon modes for dif-

ferent tin oxide phases into irreducible representations and compute^{36,37} the energy $\hbar\omega$ and differential scattering cross-section $d\sigma/d\Omega$ of each symmetric representation using density functional perturbation theory. For litharge SnO, the analysis yields four Raman-active representations with energies spanning 14.2 (E_q) , 25.8 (A_{1q}) , 42.6 (B_{1g}) , and 56.3 meV (E'_g) . Computed $d\sigma/d\Omega$ values indicate that the activity of the latter two modes, B_{1q} and E'_q , are strongly suppressed, consistent with their absence in the recorded spectrum. The former two modes, for which corresponding atomic displacement patterms are illustrated in Fig. 1(a), exhibit energies that are in excellent agreement with observed peak positions. Collectively, the agreement between the theoretical and experimental findings indicate that our layers are SnO with the litharge crystallographic structure.

Figure 1(b) is an XRD θ -2 θ scan acquired from the same SnO/Al₂O₃(1 $\overline{1}02$) film using Cu $K_{\alpha 1}$ radiation. Between $2\theta = 10-110^{\circ}$, only one family of film reflections is observed. The peaks are indexed as SnO 00*l*, yielding³⁸ an out-of-plane lattice parameter $c = 0.4840 \pm 0.0005$ nm, in agreement with 0.4841 nm refined³⁹ from powder samples.⁴⁰ The absence of other reflections corroborate Raman findings, establishing phase-pure SnO layers with the litharge crystal structure.

B. Growth mechanism

X-ray diffuse scattering (XDS) and atomic force microscopy (AFM) experiments are employed to determine the growth modality of litharge SnO/Al₂O₃(1102) layers. Diffuse scattering maps, including Fig. 2(a), exhibit specular intensity oscillations⁴¹ along $k_x = 0$ which decay slowly with increasing scattering vector k_y as well as pronounced wings,⁴² which appear at a fixed tilt from the sample surface. Modeling⁴³ the intensity variation establishes that the film surface is atomically smooth with a roughness of $\rho_{\rm rms} = 1.0$ nm and that the SnO layer is fully dense with a mass density of $\rho_{\rm d} = 6.2$ g/cm³. Fully dense



FIG. 2. Spiral growth of fully dense $\text{SnO}/\text{Al}_2O_3(1\overline{1}02)$ films. (a) XDS map exhibiting diffuse wings and a decay in specular intensity that is indicative of fully dense films (6.2 g/cm³) and atomically smooth surfaces (1.0 nm roughnesses). (b) AFM amplitude image showing shallow spiral growth mounds. The overlaid height-difference correlation function has a pre-saturation slope which is consistent with high ad-atom diffusivity.

films are consistent with smooth surfaces since shallow growth mounds result in minimal atomic shadowing during film deposition.

AFM amplitude images, such as the one shown in Fig. 2(b), demonstrate that the film surface is composed of growth mounds with unit-cell-high terraces originating from ad-atom step-edge barriers^{44,45}. The step-edges orient predominately along SnO(100) and occasionally terminate at screw dislocations (areal screw dislocation density 5×10^9 cm⁻²). Overlaid on Fig. 2(b) is the surface height-difference correlation function, which statistically quantifies surface roughness as a function of distance on the sample surface.⁴⁶ The analysis reveals extremely shallow mounds with aspect ratio of 0.001 and a surface morphology that is consistent with a high degree of ad-atom diffusion during film growth.

Together, the XDS and AFM results indicate that the synthesis of SnO films on $Al_2O_3(1\overline{1}02)$ proceeds in a spiral growth mode.

C. Film structure

The nanostructure of SnO/Al₂O₃(1102) films are investigated using scanning transmission electron microscopy (STEM). A STEM micrograph acquired along the Al₂O₃ [1101] zone axis, near the film/substrate interface is presented in Fig. 3(a). The film region exhibits a pattern consistent with the litharge structure projected along the SnO [110] zone axis. Indexing nano-beam diffraction (NBD) patterns collected from the film (Fig. 3(b)) confirms the overlayer orientation and, furthermore, establishes an (001)_{SnO} || (1102)_{Al₂O₃} and [110]_{SnO} || [1120]_{Al₂O₃} epitaxial relationship. Together with XRD pole figure measurements⁴⁷, these results demonstrate that the film is an untwinned single crystal.

SnO unit cell dimensions are determined by measuring interatomic distances in Fig. 3(a) and independently confirmed via high-resolution XRD reciprocal space maps (RSMs). Figure 3(c) is a typical RSM of SnO 114 and Al_2O_3 $4\overline{2}\overline{2}6$ reflections. The film peak is centered at $k_x = 3.722 \text{ nm}^{-1}$ and $k_z = 8.264 \text{ nm}^{-1}$, yielding a fully relaxed SnO unit cell with in-plane and out-of-plane lattice parameters of $a = \sqrt{2}/k_x = 0.3800 \pm 0.0004$ nm and c = $4/k_z = 0.4840 \pm 0.0005$ nm. The centroid of the Al₂O₃ $4\overline{2}26$ reflection lies at $k_x = 4.205$ nm⁻¹ and $k_z = 8.619$ nm⁻¹, corresponding to effective lattice parameters⁴⁸ of $a_{Al_2O_3} = \sqrt{2}/k_x = 0.3363 \text{ nm and } c_{Al_2O_3} = 3/k_z = 0.3480$ nm. Based on the resulting film/substrate lattice parameter mismatch, $m = a_{Al_2O_3}/a - 1 = -12\%$, the critical thickness⁴⁹ for strain relaxation is estimated to be less than one monolayer.

The relaxation of the SnO overlayer produces a semicoherent heteroepitaxial interface comprised of a periodic array of misfit dislocations. The dislocation cores are exposed by in-plane strain isocontours computed⁵⁰⁵¹ from and overlaid on Fig. 3(a) (the raw data without the overlay is provided in Supplementary Material⁴⁷). Dis-



FIG. 3. Structural perfection of semicoherent $SnO/Al_2O_3(1\overline{1}02)$ films. (a) STEM image acquired along the Al_2O_3 [1101] zone axis near the SnO/Al_2O_3 interface. Misfit dislocations are exposed by the overlaid in-plane strain isocontours. (b) NBD pattern of the film region. Indexed reflections indicate an $(001)_{SnO} \parallel (1\overline{1}02)_{Al_2O_3}$ and $[110]_{SnO}$ || $[11\overline{2}0]_{Al_2O_3}$ epitaxial relationship. (c) RSM of SnO 114 and Al₂O₃ $4\overline{2}\overline{2}6$ peaks evincing overlayer relaxation. (d) θ - 2θ XRD scan in the vicinity of the SnO 001 peak. (e) Superimposed XRD rocking curve scans of the SnO 001 and Al_2O_3 1102 peaks, establishing substrate-limited film structural perfection. The full-width-at-half-maximum of both film and substrate ω -rocking curve peaks is 0.007° (25 arcsec). (f) Higher magnification STEM image highlighting a $0.40{\pm}0.03\text{-nm}{-}\text{wide}$ gap that develops, separating a commensurately strained monolayer of the SnO film from the remainder of the fully relaxed SnO layer. The gap, which is a signature of van der Waals epitaxy, pins dislocations as misfits near the film/substrate interface, promoting the growth of films with high structural perfection.

location cores are found to be separated on average by 2.4 nm, in excellent agreement with $a_{Al_2O_3}/m = 2.5$ nm, the expected dislocation line spacing for a fully relaxed SnO(001) film on Al₂O₃(1102).

Despite the relaxed film structure, XRD θ -2 θ thickness oscillations (Fig. 3(d)) and overlapping ω -rocking curve film and substrate peaks (Fig. 3(e)) establish that the SnO layer exhibits a high degree of structural perfection. In-plane and out-of-plane mosaic coherence lengths,⁵² $\xi_{\parallel} = 5 \ \mu \text{m}$ and $\xi_{\perp} \simeq 40 \ \text{nm}$, are determined to be limited only by the intrinsic substrate mosaicity and finite film thickness, respectively. The high structural quality of the film is consistent with the orderly arrangement of atomic columns observed via lattice-resolution STEM (Fig. 3(a)) and attributed to the formation of an intermediary interfacial structure.

Near the substrate region, high-resolution STEM images, including Fig. 3(f), show that the SnO film is divide into a commensurately strained monolayer and a fully relaxed overlayer. Separating the two sections is a 0.40 ± 0.03 -nm-wide gap (75% larger than interatomic



FIG. 4. Electronic properties of litharge SnO, a model lone pair system. (a) Theoretical SnO electronic band dispersions with states colorized and broadened according to orbital (s vs. p) and atomic (tin vs. oxygen) characters. The insert shows electron and hole pockets. (b) Charge density maps of hole pocket states reveal a lone-pair-like distribution. (c) and (d) SnO complex dielectric function $\varepsilon \equiv \varepsilon_1 + i\varepsilon_2$ resolved into ordinary xy (blue) and extraordinary z (red) components as determined from VASE (solid) and RPA calculations (dashed). (e) XPS scans as a function of photon energies between 400 and 1500 eV; the densities of states of SnO and SnO₂ are also plotted for reference.

distances in SnO) across which only weak van der Waals interactions are active⁴⁷. These features are a hallmark of van der Waals epitaxy⁵³ whereby a weaklybonded gap develops accommodating misfit dislocations and promoting films with high structural perfection despite a large lattice mismatch (-12%). Similar interfacial structures have been reported for Bi₂Te₃/GaAs(001),⁵⁴ $MoS_2/GaN(0001)$,⁵⁵ and GaSe/Si(111)^{56,57} heteroepitaxial systems, showing them to be common for the epitaxial integration of two-dimensional layered materials (e.g., SnO) on three-dimensional systems (e.g., Al₂O₃).

D. Electronic and optical properties

The electronic structure of SnO is investigated using a combination of transport measurements, variable-angle spectroscopic ellipsometry (VASE), and synchrotron x-ray photoelectron spectroscopy (XPS). Findings are in-

terpreted within the context of band dispersions, charge density distributions, and electronic densities of states computed from first principles density functional theory calculations.

Figure 4(a) shows calculated SnO band dispersions, colorized and broadened according to orbital and atomic characters, along high-symmetry reciprocal-space directions. The valence band maximum and conduction band minimum occur along $\overline{M\Gamma}$ and at M, respectively, and give rise to the hole and electron pockets shown inscribed within the first Brillouin zone in Fig. 4(a). The hole pocket has strong contributions from Sn antibonding states which assume an asymmetric lone-pair-like charge distribution (see Fig. 4(b)).

The lone pair states profoundly influence the equilibrium unit cell geometry. Rather than adopting the ideal CsCl structure for which the axial ratio c/a = 1, the SnO cell is tetragonally elongated into the litharge structure (c/a = 1.27) as a result of the electronic pressure applied by the lone pair states.^{58,59}

The transport and optical properties of SnO are also affected by the lone pair states. The room-temperature electrical resistivity of the $SnO/Al_2O_3(1\overline{1}02)$ film is determined in the SnO(001) plane from four-point probe $measurement^{60}$ using pressed indium contacts to be 101 Ω cm. Hall measurements carried out over a field range of ± 6 T indicate hole conduction with a mobility of $2.4 \text{ cm}^2 \text{V}^{-1} \text{s}^{-1}$ and a carrier density of $2.5 \times 10^{16} \text{ cm}^{-3}$ at room temperature. The measured carrier density value, which is the lowest reported to $date^{27}$, indicates trace levels of impurities and tin vacancies, a native mechanism known to engender holes⁶¹, and suggests intrinsic phonon-limited transport. The hole mobility, which is smaller than values reported for polycrystalline films,²⁷ is understood from curvature anisotropies in the lonepair hole pocket (see Fig. 4(a)), which result in effective masses that are large in the xy plane and small along zthe tetragonal axis.

SnO optical properties are probed via VASE.⁶²⁶³ The complex dielectric function $\varepsilon \equiv \varepsilon_1 + i\varepsilon_2$ is plotted as a function of photon energy $h\nu$ in Figs. 4(c) and 4(d). Prominent poles, corresponding to optical excitations, are observed at 3.0 (z), 3.6 (xy), and 4.6 eV (z'); absorption is strongly suppressed below 2.7 eV, the direct optical gap, but remain finite down to $\sim 1 \text{ eV}$, the indirect optical gap. These features are reproduced by first principle calculation based on the random phase approximation (RPA) and indicate that the optical properties of SnO are well described by single-particle-like behavior. The combined experimental and theoretical results reveal that the high degree of optical transparency below the direct gap results from the small optical matrix element involving indirect excitations between lone pair states (see Fig. 4(b)) and the conduction band minimum (see Fig. 4(a)).

Figure 4(d) show x-ray photoelectron spectroscopy valence band scans collected as a function of photon energy $h\nu$ at beamline 29-ID of the Advanced Photon Source; computed densities of states corresponding to SnO and SnO₂ are also shown. Spectra acquired at $h\nu = 1500$ eV exhibit broad valence states spanning 12 eV below the Fermi level. In addition, two peaks of approximately equal intensity are visible at -5.0 eV and -2.5 eV. As the photon energy is decreased, spectral weights shifts from the peak at -2.5 eV to the one at -5.0 eV. This evolution in spectral weight cannot be explained by an energy-dependent matrix element.⁶⁴ The changes are instead attributed to a sensitivity that changes with depth. This results from the combination of a changing photoelectron inelastic mean-free path ℓ (for $h\nu = 400$ eV, $\ell \leq 1$ nm; at $h\nu = 1500$ eV, $\ell \sim 4$ nm)⁶⁵ and the presence of a thin ($\lesssim 4$ nm) native SnO₂ layer on the air-exposed surface of the SnO film.

III. CONCLUSIONS

Despite the wide range of desirable properties associated with Sn^{2+} , tin generally prefers to adopt a 4+ oxidation state, making the stabilization of the former valence challenging. We successfully demonstrate the growth of epitaxial SnO layers with the litharge structure on Al₂O₃(1102) using molecular-beam epitaxy. In addition to quantifying the structural perfection and identifying the growth modality of the layers, we report the physical properties of our epitaxial SnO films. Our main results are summarized in Table I.

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$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$SnO/Al_2O_3(1\overline{1}02)$ film properties	Value	
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	Lattice parameters		
$\begin{array}{cccccc} \mbox{Axial ratio } c/a & 1.27 \ (1.26) & - \\ \mbox{Film/substrate mismatch } m & -12 \ \% \\ \mbox{Raman-active mode energies } \hbar \omega & \\ \mbox{E_g} & 13.7 \ (14.2) \ meV \\ \mbox{A_{1g}$} & 25.8 \ (25.8) \ meV \\ \mbox{B_{1g}$} & - \ (42.6) \ meV \\ \mbox{E'_g} & - \ (56.3) \ meV \\ \mbox{Dielectric function poles} & \\ \mbox{$\epsilon(xy)$} & 3.6 \ (3.7) \ eV \\ \mbox{$\epsilon(xy)$} & 3.6 \ (3.7) \ eV \\ \mbox{$\epsilon(xy)$} & 3.6 \ (5.0) \ eV \\ \mbox{Bandgap energies E_g} & \\ \mbox{Indirect} & 2.7 \ (2.6) \ eV \\ \mbox{Direct} & 2.7 \ (2.6) \ eV \\ \mbox{Direct} & 2.7 \ (2.6) \ eV \\ \mbox{P-type transport properties} & \\ \mbox{Resistivity ρ} & 101 \ \Omega \ cm \\ \mbox{Hole concentration p} & 2.5 \times 10^{16} \ cm^{-3} \\ \mbox{Hole mobility μ_p} & 2.4 \ cm^2 V^{-1} s^{-1} \\ \mbox{Structural attributes} & \\ \mbox{Mass density ρ_d} & 6.2 \ g/cm^3 \\ \mbox{van der Waals gap δ} & 0.3983 \ nm \\ \mbox{Surface roughness ρ_{rms}} & 1.0 \ nm \\ \mbox{Screw dislocation density ρ_s} & 5 \times 10^9 \ cm^{-2} \\ \end{array}$	In-plane a	0.3800(0.3807)	nm
$\begin{array}{cccc} \mbox{Film/substrate mismatch m} & -12 \ \% \\ \mbox{Raman-active mode energies $\hbar ω} \\ E_g & 13.7 \ (14.2) \ mV \\ A_{1g} & 25.8 \ (25.8) \ mV \\ -(42.6) \ mV \\ E'_g & -(42.6) \ mV \\ -(56.3) \ mV \\ \hline \end{array} \\ \begin{array}{c} \mbox{Dielectric function poles} \\ \epsilon(z) & 3.0 \ (3.5) \ eV \\ \epsilon(z') & 3.6 \ (3.7) \ eV \\ \epsilon(z') & 4.6 \ (5.0) \ eV \\ \hline \end{array} \\ \begin{array}{c} \mbox{Bandgap energies E_g} \\ \mbox{Indirect} & -1 \ (<0) \ eV \\ \hline \mbox{Direct} & 2.7 \ (2.6) \ eV \\ \hline \mbox{P-type transport properties} \\ \hline \mbox{Resistivity ρ} & 101 \ \Omega \ cm \\ \hline \mbox{Hole concentration p} \\ \hline \mbox{Hole mobility μ_p} & 2.4 \ cm^2V^{-1}s^{-1} \\ \hline \mbox{Structural attributes} \\ \hline \mbox{Mass density ρ_d} & 6.2 \ g/cm^3 \\ \hline \mbox{under Waals gap δ} \\ \hline \mbox{Surface roughness ρ_{rms}} & 1.0 \ nm \\ \mbox{Screw dislocation density ρ_s} & 5 \times 10^9 \ cm^{-2} \\ \hline \end{array}$	Out-of-plane c	0.4840(0.4804)	nm
$\begin{array}{llllllllllllllllllllllllllllllllllll$	Axial ratio c/a	1.27(1.26)	
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	Film/substrate mismatch m	-12	%
$\begin{array}{cccccccc} A_{1g} & 25.8 & (25.8) & \mathrm{meV} \\ B_{1g} & -& (42.6) & \mathrm{meV} \\ E'_g & & -& (56.3) & \mathrm{meV} \\ \hline \text{Dielectric function poles} & & & & & & & & & & & & & & & & & & &$	Raman-active mode energies $\hbar\omega$		
$\begin{array}{cccc} B_{1g} & & - (42.6) \ \mathrm{meV} \\ E'_g & & - (56.3) \ \mathrm{meV} \\ \hline \mathrm{Dielectric \ function \ poles} \\ \epsilon(z) & & 3.0 \ (3.5) \ \mathrm{eV} \\ \epsilon(xy) & & 3.6 \ (3.7) \ \mathrm{eV} \\ \epsilon(z') & & 4.6 \ (5.0) \ \mathrm{eV} \\ \hline \mathrm{Bandgap \ energies} \ E_g \\ \hline \mathrm{Indirect} & & \sim 1 \ (<0) \ \mathrm{eV} \\ \hline \mathrm{Direct} & & 2.7 \ (2.6) \ \mathrm{eV} \\ \hline p\text{-type \ transport \ properties} \\ \hline \mathrm{Resistivity} \ \rho & & 101 \ \Omega \ \mathrm{cm} \\ \hline \mathrm{Hole \ concentration} \ p & & 2.5 \times 10^{16} \ \mathrm{cm}^{-3} \\ \hline \mathrm{Hole \ mobility} \ \mu_p & & 2.4 \ \mathrm{cm}^2 \mathrm{V}^{-1} \mathrm{s}^{-1} \\ \hline \mathrm{Structural \ attributes} & & \\ \hline \mathrm{Mass \ density} \ \rho_{\mathrm{d}} & & 6.2 \ \mathrm{g/cm}^{3} \\ \mathrm{van \ der \ Waals \ gap \ \delta} & & 0.3983 \ \mathrm{nm} \\ \mathrm{Surface \ roughness \ } \rho_{\mathrm{rms}} & & 1.0 \ \mathrm{nm} \\ \mathrm{Screw \ dislocation \ density} \ \rho_{\mathrm{s}} & & 5 \times 10^{9} \ \mathrm{cm}^{-2} \end{array}$	E_g	13.7(14.2)	meV
$\begin{array}{cccc} E_g' & (56.3) \ \mathrm{meV} \\ \hline \text{Dielectric function poles} & & \\ \epsilon(z) & & & \\ \epsilon(xy) & & & \\ \epsilon(z') & & & \\ \text{Bandgap energies } E_g \\ & & \\ \text{Indirect} & & & \\ \rho\text{-type transport properties} \\ & & \\ \text{Resistivity } \rho & & & \\ \text{Hole concentration } p & & & \\ \text{Hole mobility } \mu_p & & & \\ \text{Mass density } \rho_d & & & \\ \text{Mass density } \rho_d & & & \\ \text{Mass density } \rho_d & & & \\ \text{van der Waals gap } \delta & & & \\ \text{Structural attributes} & & \\ & & \\ \text{Mass density } \rho_{\mathrm{rms}} & & & \\ \text{Structarial attributes} & & \\ & & \\ \text{Structural attributes} & & \\ & & \\ \text{Structural attributes} & & \\ & & \\ \text{Surface roughness } \rho_{\mathrm{rms}} & & \\ & & \\ \text{Strue dislocation density } \rho_{\mathrm{s}} & & \\ \end{array} $	A_{1g}	25.8(25.8)	meV
$\begin{array}{cccc} E_g' & (56.3) \ \mathrm{meV} \\ \hline \text{Dielectric function poles} & & \\ \epsilon(z) & & & \\ \epsilon(xy) & & & \\ \epsilon(z') & & & \\ \text{Bandgap energies } E_g \\ & & \\ \text{Indirect} & & & \\ \rho\text{-type transport properties} \\ & & \\ \text{Resistivity } \rho & & & \\ \text{Hole concentration } p & & & \\ \text{Hole mobility } \mu_p & & & \\ \text{Mass density } \rho_d & & & \\ \text{Mass density } \rho_d & & & \\ \text{Mass density } \rho_d & & & \\ \text{van der Waals gap } \delta & & & \\ \text{Structural attributes} & & \\ & & \\ \text{Mass density } \rho_{\mathrm{rms}} & & & \\ \text{Structarial attributes} & & \\ & & \\ \text{Structural attributes} & & \\ & & \\ \text{Structural attributes} & & \\ & & \\ \text{Surface roughness } \rho_{\mathrm{rms}} & & \\ & & \\ \text{Strue dislocation density } \rho_{\mathrm{s}} & & \\ \end{array} $	B_{1g}	-(42.6)	meV
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	E'_{q}		
$\begin{array}{cccc} \epsilon(xy) & 3.6 & (3.7) \ {\rm eV} \\ \epsilon(z') & 4.6 & (5.0) \ {\rm eV} \\ \\ \mbox{Bandgap energies } E_{\rm g} & & \\ \mbox{Indirect} & \sim 1 & (<0) \ {\rm eV} \\ \\ \mbox{Direct} & 2.7 & (2.6) \ {\rm eV} \\ \\ \mbox{p-type transport properties} \\ \\ \mbox{Resistivity } \rho & 101 \ \Omega \ {\rm cm} \\ \\ \mbox{Hole concentration } p & 2.5 \times 10^{16} \ {\rm cm}^{-3} \\ \\ \mbox{Hole mobility } \mu_p & 2.4 \ {\rm cm}^2 {\rm V}^{-1} {\rm s}^{-1} \\ \\ \mbox{Structural attributes} & \\ \\ \\ \\ \mbox{Mass density } \rho_{\rm d} & 6.2 \ {\rm g/cm}^3 \\ \\ \mbox{van der Waals gap } \delta & 0.3983 \ {\rm nm} \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\$	Dielectric function poles		
$\begin{array}{cccc} \epsilon(xy) & 3.6 & (3.7) \ {\rm eV} \\ \epsilon(z') & 4.6 & (5.0) \ {\rm eV} \\ \\ \mbox{Bandgap energies } E_{\rm g} & & \\ \mbox{Indirect} & \sim 1 & (<0) \ {\rm eV} \\ \\ \mbox{Direct} & 2.7 & (2.6) \ {\rm eV} \\ \\ \mbox{p-type transport properties} \\ \\ \mbox{Resistivity } \rho & 101 \ \Omega \ {\rm cm} \\ \\ \mbox{Hole concentration } p & 2.5 \times 10^{16} \ {\rm cm}^{-3} \\ \\ \mbox{Hole mobility } \mu_p & 2.4 \ {\rm cm}^2 {\rm V}^{-1} {\rm s}^{-1} \\ \\ \mbox{Structural attributes} & \\ \\ \\ \\ \mbox{Mass density } \rho_{\rm d} & 6.2 \ {\rm g/cm}^3 \\ \\ \mbox{van der Waals gap } \delta & 0.3983 \ {\rm nm} \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\$	$\epsilon(z)$	3.0(3.5)	eV
$\begin{array}{cccc} \epsilon(z') & 4.6 \ (5.0) \ {\rm eV} \\ {\rm Bandgap \ energies} \ E_{\rm g} & & \\ {\rm Indirect} & & \sim 1 \ (<0) \ {\rm eV} \\ {\rm Direct} & & 2.7 \ (2.6) \ {\rm eV} \\ p\mbox{-type \ transport \ properties} \\ {\rm Resistivity} \ \rho & & 101 \ \Omega \ {\rm cm} \\ {\rm Hole \ concentration} \ p & & 2.5 \times 10^{16} \ {\rm cm}^{-3} \\ {\rm Hole \ mobility} \ \mu_p & & 2.4 \ {\rm cm}^2 {\rm V}^{-1} {\rm s}^{-1} \\ {\rm Structural \ attributes} & \\ {\rm Mass \ density} \ \rho_{\rm d} & & 6.2 \ {\rm g/cm}^3 \\ {\rm van \ der \ Waals \ gap} \ \delta & & 0.3983 \ {\rm nm} \\ {\rm Surface \ roughness} \ \rho_{\rm rms} & & 1.0 \ {\rm nm} \\ {\rm Screw \ dislocation \ density} \ \rho_{\rm s} & & 5 \times 10^9 \ {\rm cm}^{-2} \end{array}$		3.6(3.7)	eV
$\begin{array}{cccc} & -1 \ (<0) \ {\rm eV} \\ {\rm Direct} & 2.7 \ (2.6) \ {\rm eV} \\ p\mbox{-type transport properties} \\ {\rm Resistivity} \ \rho & 101 \ \Omega \ {\rm cm} \\ {\rm Hole \ concentration} \ p & 2.5 \times 10^{16} \ {\rm cm}^{-3} \\ {\rm Hole \ mobility} \ \mu_p & 2.4 \ {\rm cm}^2 {\rm V}^{-1} {\rm s}^{-1} \\ {\rm Structural \ attributes} & \\ {\rm Mass \ density} \ \rho_{\rm d} & 6.2 \ {\rm g/cm}^3 \\ {\rm van \ der \ Waals \ gap} \ \delta & 0.3983 \ {\rm nm} \\ {\rm Surface \ roughness} \ \rho_{\rm rms} & 1.0 \ {\rm nm} \\ {\rm Screw \ dislocation \ density} \ \rho_{\rm s} & 5 \times 10^9 \ {\rm cm}^{-2} \end{array}$			
$\begin{array}{llllllllllllllllllllllllllllllllllll$	Bandgap energies $E_{\rm g}$		
$\begin{array}{llllllllllllllllllllllllllllllllllll$	Indirect	$\sim 1 \; (<0)$	eV
$\begin{array}{llllllllllllllllllllllllllllllllllll$	Direct		
Hole concentration p $2.5 \times 10^{16} \text{ cm}^{-3}$ Hole mobility μ_p $2.4 \text{ cm}^2 \text{V}^{-1} \text{s}^{-1}$ Structural attributes δ Mass density ρ_d 6.2 g/cm^3 van der Waals gap δ 0.3983 nm Surface roughness $\rho_{\rm rms}$ 1.0 nm Screw dislocation density $\rho_{\rm s}$ $5 \times 10^9 \text{ cm}^{-2}$	<i>p</i> -type transport properties		
Hole mobility μ_p $2.4 \text{ cm}^2 \text{V}^{-1} \text{s}^{-1}$ Structural attributesMass density ρ_d 6.2 g/cm^3 Van der Waals gap δ 0.3983 nm Surface roughness $\rho_{\rm rms}$ 1.0 nm Screw dislocation density $\rho_{\rm s}$ $5 \times 10^9 \text{ cm}^{-2}$	Resistivity ρ	101	$\Omega \ {\rm cm}$
$ \begin{array}{ll} \mbox{Hole mobility μ_p} & 2.4 \ \mbox{cm}^2 \mbox{V}^{-1} \mbox{s}^{-1} \\ \mbox{Structural attributes} & & & \\ \mbox{Mass density ρ_d} & & 6.2 \ \mbox{g/cm}^3 \\ \mbox{van der Waals gap δ} & & 0.3983 \ \mbox{nm} \\ \mbox{Surface roughness $\rho_{\rm rms}$} & & 1.0 \ \mbox{nm} \\ \mbox{Screw dislocation density $\rho_{\rm s}$} & & 5 \times 10^9 \ \mbox{cm}^{-2} \end{array} $	Hole concentration p	2.5×10^{16}	cm^{-3}
Mass density ρ_d 6.2 g/cm ³ van der Waals gap δ 0.3983 nmSurface roughness $\rho_{\rm rms}$ 1.0 nmScrew dislocation density $\rho_{\rm s}$ 5×10^9 cm ⁻²	_	2.4	$\mathrm{cm}^{2}\mathrm{V}^{\text{-1}}\mathrm{s}^{\text{-1}}$
van der Waals gap δ 0.3983 nmSurface roughness $\rho_{\rm rms}$ 1.0 nmScrew dislocation density $\rho_{\rm s}$ $5 \times 10^9 \ {\rm cm}^{-2}$	Structural attributes		
van der Waals gap δ 0.3983 nmSurface roughness $\rho_{\rm rms}$ 1.0 nmScrew dislocation density $\rho_{\rm s}$ $5 \times 10^9 \ {\rm cm}^{-2}$	Mass density $\rho_{\rm d}$	6.2	g/cm^3
Screw dislocation density $\rho_{\rm s}$ 5 × 10 ⁹ cm ⁻²	van der Waals gap δ		- /
0 1 -	Surface roughness $\rho_{\rm rms}$	1.0	nm
0 1 -	Screw dislocation density $\rho_{\rm s}$	5×10^9	cm^{-2}
Mosaic conerence lengths	Mosaic coherence lengths		
In-plane ξ_{\parallel} 5 μ m	_	5	$\mu \mathrm{m}$
Out-of-plane ξ_{\perp} ~ 40 nm	11		,

TABLE I. Summary of experimentally determined physical properties measured from a phase-pure, untwinned, relaxed, epitaxial litharge $\text{SnO}/\text{Al}_2\text{O}_3(1\overline{1}02)$ layer grown via molecular-beam epitaxy at 380 °C in an O₂ background partial pressure of 5×10^{-7} Torr. Values obtained from first-principles calculations are shown in parentheses.

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$$\epsilon(\vec{r}) = \frac{-1}{2\pi} \sum_{\vec{g}} \vec{d}_{\vec{g}} \cdot \vec{\nabla}_{\vec{r}} \{ \angle I_{\vec{g}}(\vec{r}) - 2\pi \vec{g} \cdot \vec{r} \}$$
(1)

are determined by applying the real-space gradient operator $\vec{\nabla}$ to the argument of the \vec{g} -filtered image $I_g(\vec{r}) = \mathcal{F}_{\vec{g}}^{-1} \{\mathcal{F}[I(\vec{r})](\vec{k})\}(\vec{r})$ and taking the dot product of the result with $\vec{d}_{\vec{g}}$, the conjugate of \vec{g} (\mathcal{F} is the Fourier transform operator). The phase ambiguity is removed by evaluating the gradient of the phase field $\psi(\vec{r})$ on the complex plane using $\partial \psi(\vec{r}) = \text{Im}\{e^{-i\psi(\vec{r})}\partial e^{i\psi(\vec{r})}\}$.

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